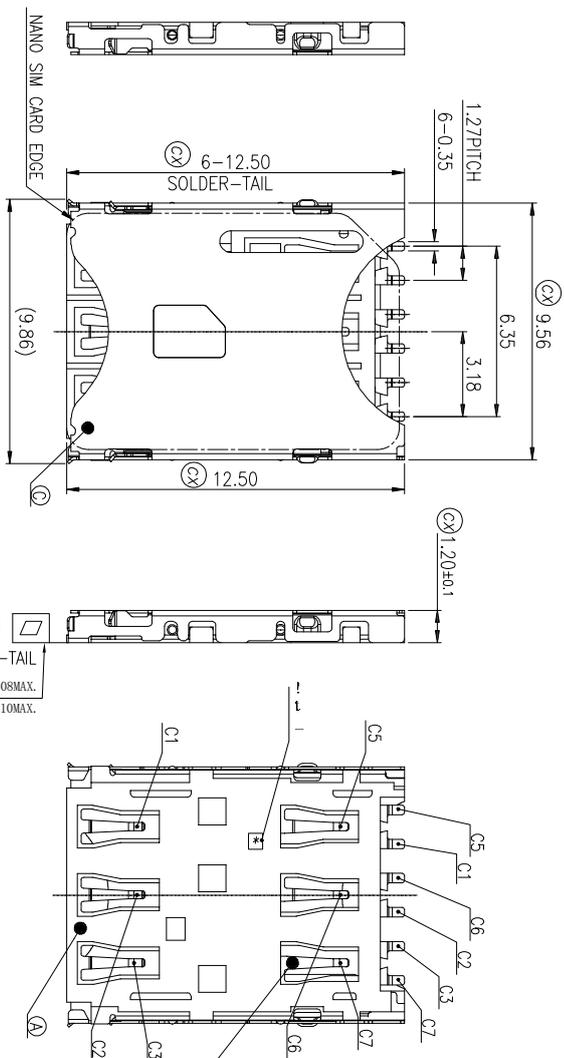
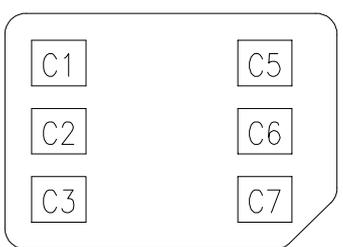


\* 所有原材料, 生产制程, 电镀必须符合IP要求

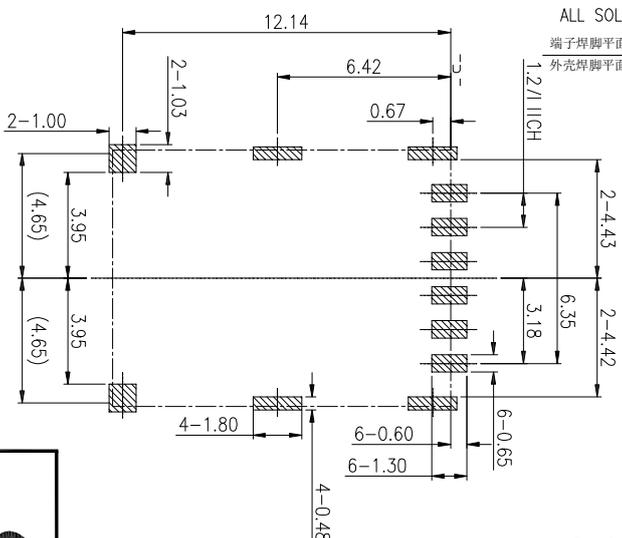


ALL SOLDER-TAIL  
端子焊脚平面度0.08MAX.  
外壳焊脚平面度0.10MAX.



NANO SIM CARD PAD

RECOMMENDED P.C.B. LAYOUT  
TOLERANCE (TOP VIEW) ±0.05mm



- SPECIFICATIONS:
- ELECTRICAL CHARACTERISTICS:
    - CURRENT RATING: 1A
    - DIELECTRIC WITHSTANDING VOLTAGE: 500V R.M.S. MIN;
    - INSULATION RESISTANCE: 500MΩ MIN.
    - CONTACT RESISTANCE: 100mΩ MAX. (INITIAL)
  - LIFE TEST: 1500 CYCLES.
  - OTHER GENERAL SPEC. TO REFER "2SM2021-000111F SPEC".
  - TO CONFORM TO SINGATRON HAZARDOUS SUBSTANCE FREE SPEC.
  - HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT: ©
  - HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING: ©
  - FOR REFLOW SOLDERING LEAD-FREE PROCESS.
  - PACKAGING: TAPE & REEL.
  - REPRESENT CRITICAL DIMENSIONS.
  - REPRESENT CPK DIMENSIONS.



NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
C	SHELL	1	STAINLESS STEEL, 0.10T	NICKEL PLATING OVER ALL
B	CONTACT	1	COPPER ALLOY, 0.10T	GOLD FLASH ON CONTACT AREA AND SOLDER AREA 50μ" MIN NICKEL UNDER-PLATED
A	HOUSING	1	HIGH TEMP. THERMOPLASTIC UL 94V-0	BLACK



深圳市鑫南天科技有限公司  
Shen zhen Shi Xin Nan Tian Industrial Co., Ltd

PRODUCT NAME: NANO SIM H1.20  
PRODUCT NO.: XNT-T1161-01  
DRAWING NO.: D-NS120-T1161-01  
DATE: 2021.10.13

DIMENSIONS UNITS: mm  
UNLESS OTHERWISE SPECIFIABLE  
DIMENSION TOLERANCE  
X.X: ± 0.20  
X.XX: ± 0.10  
X.XXX: ± 0.05  
ANGULAR: ± 1°

CHECK: Ag  
APPROVED: Jeff Iin  
DATE: 2021.10.13  
SCALE: 1:1  
DWG ID: P D  
REV.: A  
PAGE: 1 of 1

REVISION NO.	EGR NO.	DESCRIPTION	MARK	DATE
A	---	NEW RELEASE	FAUJ	2021.10.13